# Resonator

# Piezoelectric Resonator (8 to 16 MHz)

# FAR Family (C4 series G type)

### DESCRIPTION

Fujitsu resonators C4 series (G type) feature originally developed single crystals with a high electromechanical coefficient (LiNbO<sub>3</sub> lithium niobate), the result is ultra compact packaging. C4 series (G type) with built-in capacitors for exclusive use in microcomputer clocks, and this series is chip type device for surface-mount.

### FEATURES

- Ultra compact package.
- Wide frequency range in 8 to 16 MHz.
- C4 (G type), with built-in capacitors, is the best suited to the source of microcomputer clocks.
- C4 (G type) can be shipped in emboss-typed packages for automatic mounting.
- The resonators have superior shock and vibration resistance, preventing damage during automatic mounting process.

### PACKAGE



### ■ STANDARD CHARACTERISTICS

Series Parameter	C4 series (G type)	Remarks
Material	Lithium Niobate (LiNbO3)	
Frequency	8 to 16 MHz	
Standard frequency	See "■ Standard Frequency."	
Initial frequency deviation	±0.5% (µ)	
Temperature characteristics (–20°C to 60°C)	±0.5%	
Capacity of built-in capacitor	20±8 pF (Standard)	10±4 pF type are also available. However, the characteristics of 10±4 pF type should be specified by Fujitsu, considering matching data with applied IC (mainly microcomputer.)
Aging stability	Within +0.1%	
	-30°C to +85°C	
Storage temperature	_40°C to ±100°C	
Standard measuring circuit	(1) Oscillation frequency $1 \text{ M}\Omega$ $1 \text{ C}_2$ 2  M $1 \text{ C}_2$ 1  M MHz to 10 MHz IC: 1/6 MB84069B x 2 1  M IC: 1/6 MC74HC04 x 2 2  M $1 \text{ C}_2$ : Loading capacitance (	(2) Serial resonant resistance → → → → → → → → → →

### ■ STANDARD FREQUENCY

Standard frequency (KHz)	Package size	Resonant resistance
8,000 10,000	G	100 $\Omega$ max. (Symbol: 5)
11,000 11,059 12,000 16,000	G	75 Ω max. (Symbol: 2)

Note: • For oscillation frequency (in 8 to 16 MHz) other than standard, Fujitsu can also develop applicable part. • Resonant resistance of the part is specified according to applied frequency as above.

### NOTES ON USE

- Handle carefully
- Solder under the following conditions.
  5 seconds max. at 230°C (PCB)
  Do not apply extreme heat to the resonator. Recommended preheating is 150°C for one minute.
- Avoid extreme fluctuations in temperature during use.
- There is no specific direction in resonator mounting.
- Oscillation data should be examined when used in oscillation circuit with micon or other ICs.
- This is for reflow solder, not for flow solder.

### ■ PART NUMBERING SYSTEM

<u>FAR - C4</u>	<u>C</u> <u>G</u> –		- 🗆		□ – <u>R</u>	
(1)	(2) (3)	(4)	(5)	(6)	(7) (8) (9)	

(1) Series

Series	Single crystal	Capacitor
C4	LiNbO3	With built-in capacitors

(2) Package Type

Specification	Туре
С	Chip type

(3) Package Size

Specification	Size
G	G type(Ultra compact)

(4) Frequency (KHz) See "■ Standard Frequency." [Example] 8.0 MHz 08000

(5) Initial Frequency Deviation

Specification	Deviation
М	±0.5%

(6) Built-in Capacitor

Specification	Capacitance
0	20±8 pF
1	10±4 pF

(7) Resonant Resistance

Specification	Resonant resistance
2	75 Ω max.
5	100 Ω max.

(8) User-specific Special Symbols

Specification	Description
Name	No specification, no taping specification
_	No specification, with taping specification
A to Z	Serial number for custom design

#### (9) Taping Specification

Specification	Description
R	12 mm width tape & reel

#### ■ MARKING



### ■ PIN ASSIGNMENT



### ■ DIMENSIONS



#### ■ TAPE & REEL DIMENSIONS



### RESONATOR BUSINESS FLOW CHART

Oscillation frequency should be varied according to applied micro controller or another IC's. Fujitsu should recommend the resonator parts considering matching condition with applied IC. Following shows business flow chart.



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